

FLM1314-3F

X, Ku-Band Internally Matched FET

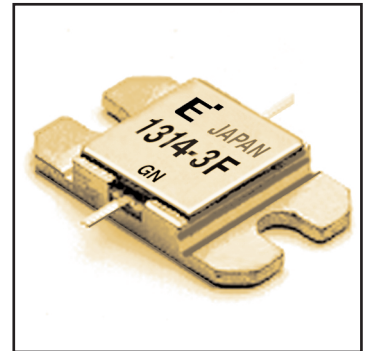
FEATURES

- High Output Power: $P_{1dB} = 35.0\text{dBm}$ (Typ.)
- High Gain: $G_{1dB} = 5.5\text{dB}$ (Typ.)
- High PAE: $\eta_{add} = 25\%$ (Typ.)
- Low $IM_3 = -45\text{dBc}@P_o = 24.0\text{dBm}$
- Broad Band: 13.75 ~ 14.5GHz
- Impedance Matched $Z_{in}/Z_{out} = 50\Omega$

DESCRIPTION

The FLM1314-3F is a power GaAs FET that is internally matched for standard communication bands to provide optimum power and gain in a 50 ohm system.

Eudyna's stringent Quality Assurance Program assures the highest reliability and consistent performance.



ABSOLUTE MAXIMUM RATING (Ambient Temperature $T_a=25^\circ\text{C}$)

| Item | Symbol | Condition | Rating | Unit |
|-------------------------|-----------|--------------------------|-------------|------------------|
| Drain-Source Voltage | V_{DS} | | 15 | V |
| Gate-Source Voltage | V_{GS} | | -5 | V |
| Total Power Dissipation | P_T | $T_c = 25^\circ\text{C}$ | 25.0 | W |
| Storage Temperature | T_{stg} | | -65 to +175 | $^\circ\text{C}$ |
| Channel Temperature | T_{ch} | | 175 | $^\circ\text{C}$ |

Fujitsu recommends the following conditions for the reliable operation of GaAs FETs:

1. The drain-source operating voltage (V_{DS}) should not exceed 10 volts.
2. The forward and reverse gate currents should not exceed 13.0 and -1.4 mA respectively with gate resistance of 100 Ω .

ELECTRICAL CHARACTERISTICS (Ambient Temperature $T_a=25^\circ\text{C}$)

| Item | Symbol | Test Conditions | Limit | | | Unit |
|--------------------------------------|-----------------|--|-------|------|-----------|--------------------|
| | | | Min. | Typ. | Max. | |
| Saturated Drain Current | I_{DSS} | $V_{DS} = 5\text{V}, V_{GS} = 0\text{V}$ | - | 1400 | 2100 | mA |
| Transconductance | g_m | $V_{DS} = 5\text{V}, I_{DS} = 900\text{mA}$ | - | 1300 | - | mS |
| Pinch-off Voltage | V_p | $V_{DS} = 5\text{V}, I_{DS} = 70\text{mA}$ | -0.5 | -1.5 | -3.0 | V |
| Gate Source Breakdown Voltage | V_{GSO} | $I_{GS} = -70\mu\text{A}$ | -5.0 | - | - | V |
| Output Power at 1dB G.C.P. | P_{1dB} | $V_{DS} = 10\text{V},$ $I_{DS} = 0.6 I_{DSS}$ (Typ.), $f = 13.75 \sim 14.5 \text{GHz},$ $Z_S = Z_L = 50 \text{ohm}$ | 34.0 | 35.0 | - | dBm |
| Power Gain at 1dB G.C.P. | G_{1dB} | | 5.0 | 5.5 | - | dB |
| Drain Current | I_{dsr} | | - | 900 | 1100 | mA |
| Power-added Efficiency | η_{add} | | - | 25 | - | % |
| Gain Flatness | ΔG | | - | - | ± 0.6 | dB |
| 3rd Order Intermodulation Distortion | IM_3 | $f = 14.5\text{GHz}, \Delta f = 10 \text{MHz}$ 2-Tone Test $P_{out} = 24.0\text{dBm S.C.L.}$ | -42 | -45 | - | dBc |
| Thermal Resistance | R_{th} | Channel to Case | - | 5.0 | 6.0 | $^\circ\text{C/W}$ |
| Channel Temperature Rise | ΔT_{ch} | $10\text{V} \times I_{dsr} \times R_{th}$ | - | - | 66 | $^\circ\text{C}$ |

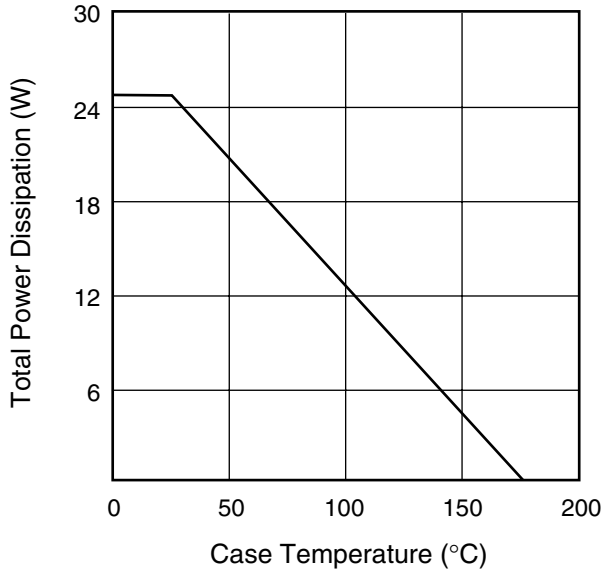
CASE STYLE: IA

G.C.P.: Gain Compression Point, S.C.L.: Single Carrier Level

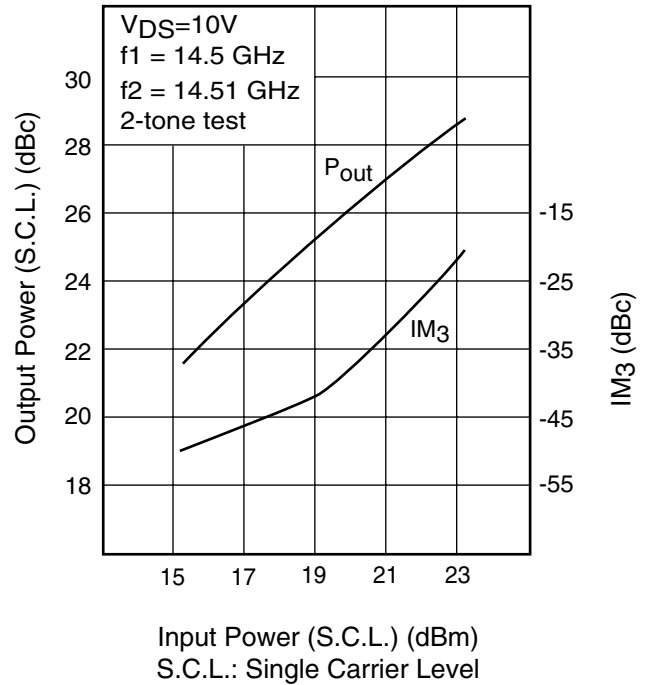
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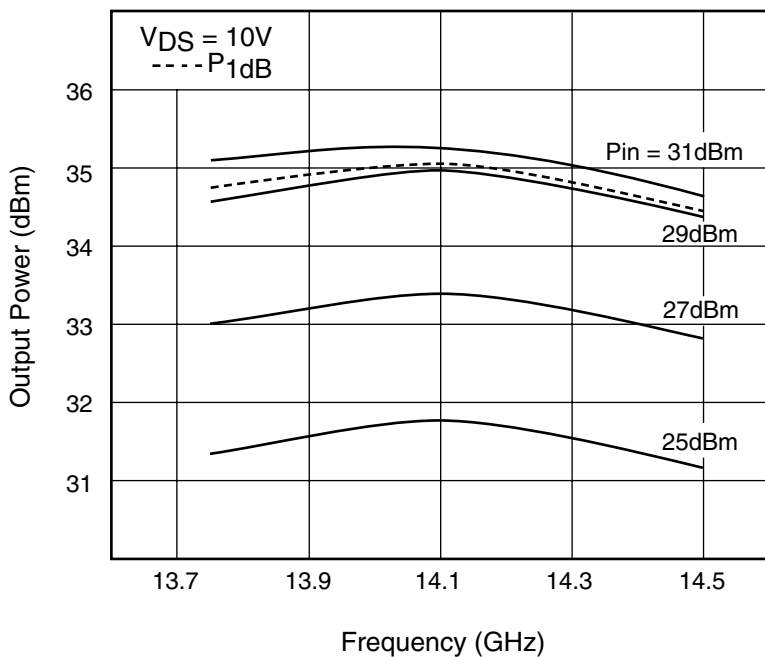
POWER DERATING CURVE



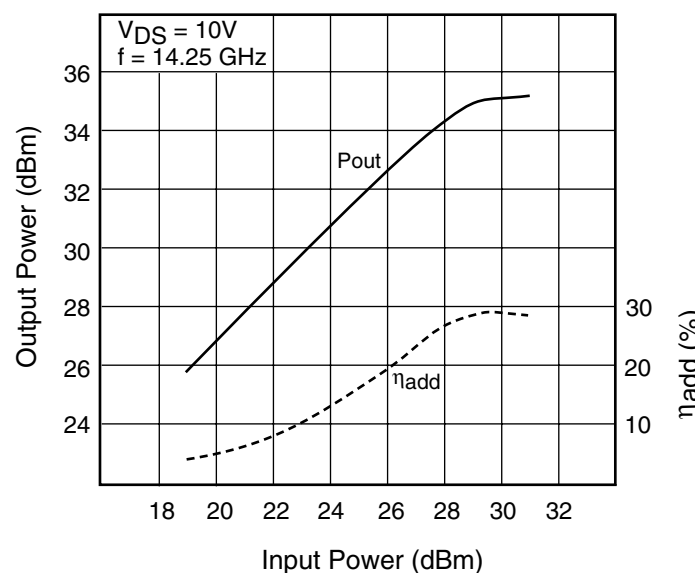
OUTPUT POWER & IM₃ vs. INPUT POWER



OUTPUT POWER vs. FREQUENCY

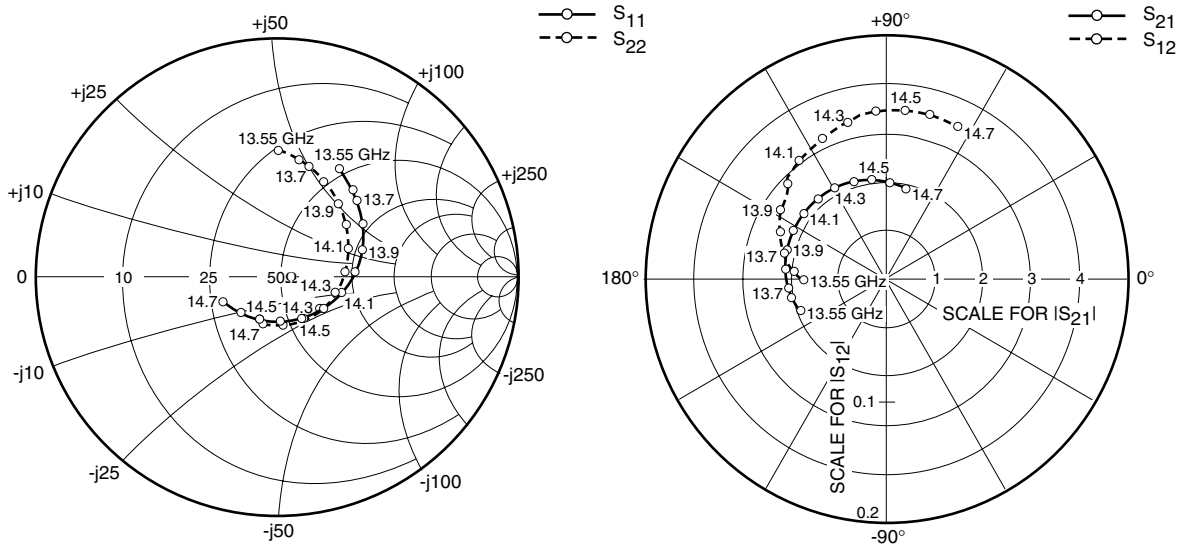


OUTPUT POWER vs. INPUT POWER



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S-PARAMETERS

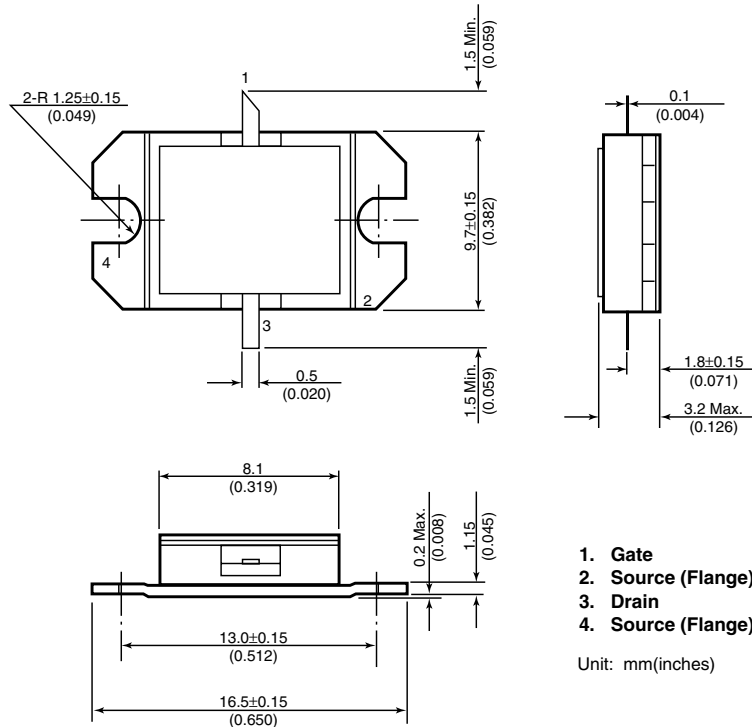
$V_{DS} = 10V, I_{DS} = 900mA$

| FREQUENCY (MHZ) | S11 | | S21 | | S12 | | S22 | |
|--------------------|------|--------|-------|--------|------|--------|------|--------|
| | MAG | ANG | MAG | ANG | MAG | ANG | MAG | ANG |
| 1355 | .522 | 60.0 | 1.928 | -160.3 | .071 | -179.5 | .527 | 89.5 |
| 1360 | .503 | 54.7 | 1.973 | -165.0 | .079 | 176.8 | .511 | 84.8 |
| 1365 | .485 | 49.3 | 2.012 | -169.9 | .083 | 171.6 | .496 | 79.6 |
| 1370 | .461 | 43.5 | 2.044 | -175.0 | .087 | 165.4 | .475 | 74.6 |
| 1375 | .440 | 37.4 | 2.080 | 179.9 | .090 | 161.9 | .458 | 69.3 |
| 1380 | .418 | 31.2 | 2.114 | 174.5 | .096 | 156.3 | .438 | 63.7 |
| 1385 | .394 | 24.4 | 2.145 | 169.3 | .102 | 150.8 | .419 | 57.5 |
| 1390 | .370 | 17.6 | 2.160 | 163.8 | .105 | 146.9 | .398 | 50.7 |
| 1395 | .344 | 10.0 | 2.181 | 158.3 | .109 | 139.7 | .376 | 44.2 |
| 1400 | .322 | 2.1 | 2.187 | 153.1 | .115 | 136.8 | .355 | 36.7 |
| 1405 | .299 | -6.0 | 2.197 | 147.5 | .120 | 130.8 | .333 | 29.1 |
| 1410 | .275 | -15.0 | 2.196 | 142.0 | .123 | 127.0 | .318 | 21.3 |
| 1415 | .255 | -24.8 | 2.193 | 136.5 | .126 | 121.4 | .297 | 12.3 |
| 1420 | .235 | -35.9 | 2.186 | 130.8 | .128 | 115.3 | .278 | 3.8 |
| 1425 | .220 | -46.3 | 2.174 | 125.4 | .132 | 110.1 | .263 | -5.8 |
| 1430 | .205 | -58.6 | 2.152 | 119.9 | .133 | 104.5 | .245 | -16.4 |
| 1435 | .195 | -71.6 | 2.133 | 114.5 | .137 | 100.3 | .232 | -27.5 |
| 1440 | .190 | -85.3 | 2.107 | 109.0 | .138 | 94.1 | .219 | -37.7 |
| 1445 | .190 | -98.6 | 2.081 | 103.7 | .139 | 89.4 | .209 | -49.3 |
| 1450 | .193 | -111.2 | 2.042 | 98.7 | .139 | 84.0 | .205 | -60.7 |
| 1455 | .199 | -123.6 | 2.021 | 93.4 | .140 | 79.5 | .204 | -71.8 |
| 1460 | .212 | -135.6 | 1.984 | 88.3 | .141 | 74.9 | .206 | -83.4 |
| 1465 | .223 | -146.3 | 1.944 | 83.4 | .139 | 69.1 | .205 | -93.7 |
| 1470 | .245 | -155.5 | 1.909 | 78.2 | .138 | 65.4 | .211 | -104.6 |

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Case Style "IA" Metal-Ceramic Hermetic Package



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CAUTION

Eudyna Devices Inc. products contain **gallium arsenide (GaAs)** which can be hazardous to the human body and the environment. For safety, observe the following procedures:

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.

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